

10/823,149

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	519	257/334	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:24
L2	4229	257/347	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:24
L3	362	257/520	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:24
L4	270	257/613	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:25
L5	696	257/632	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:25
L6	285	257/639	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:25
L7	606	257/640	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:25
L8	201	257/641	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:25

L9	586	257/642	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:25
L10	295	257/643	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:25
L11	221	257/646	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:25
L12	107	257/648	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:25
L13	493	257/649	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:25
L14	70	257/652	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 16:25
S20	1	10/823149	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 11:10
S21	1	09/970787	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 11:14
S22	1	"6209484".PN.	USPAT; USOCR	OR	ON	2005/10/20 11:13
S23	1	"6127262".PN.	USPAT; USOCR	OR	ON	2005/10/20 11:14

S24	1	"5585304".PN.	USPAT; USOCR	OR	ON	2005/10/20 11:14
S25	1	("6753260").PN.	USPAT	OR	OFF	2005/10/20 13:48
S26	4	(composite adj etch\$ adj stop) and TEOS and oxide and opening	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 13:53
S27	1	("6284657").PN.	USPAT	OR	OFF	2005/10/20 13:53
S28	1	("6114250").PN.	USPAT	OR	OFF	2005/10/20 13:53
S29	1	S27 and (composite or etch or etching or stop or stopper or integrated or circuit or TEOS or overlying or carbon or silicon or carbide or thickness or silicate or polyimide or oxide or metal or source or drain or dual or damascene or copper or aluminum or opening)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 14:03
S30	1	S28 and (composite or etch or etching or stop or stopper or integrated or circuit or TEOS or overlying or carbon or silicon or carbide or thickness or silicate or polyimide or oxide or metal or source or drain or dual or damascene or copper or aluminum or opening)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 14:04
S31	1	("6209484").PN.	USPAT	OR	OFF	2005/10/20 14:04
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S33	1	("6127262").PN.	USPAT	OR	OFF	2005/10/20 14:09
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S35	1	("5585304").PN.	USPAT	OR	OFF	2005/10/20 14:10

S36	1	S35 and (composite or etch or etching or stop or stopper or integrated or circuit or TEOS or overlying or carbon or silicon or carbide or thickness or silicate or polyimide or oxide or metal or source or drain or dual or damascene or copper or aluminum or opening)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 14:25
S37	120	(etch\$ adj stop\$) and (TEOS adj oxide) and opening and dual and damascene	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 14:19
S38	29	(etch\$ adj stop\$) and (TEOS adj oxide) and opening and dual and damascene and composite and silicon	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 14:24
S39	1	("5880018").PN.	USPAT	OR	OFF	2005/10/20 14:24
S40	1	("6723631").PN.	USPAT	OR	OFF	2005/10/20 14:24
S41	1	("6110826").PN.	USPAT	OR	OFF	2005/10/20 14:25
S42	1	S41 and (composite or etch or etching or stop or stopper or integrated or circuit or TEOS or overlying or carbon or silicon or carbide or thickness or silicate or polyimide or oxide or metal or source or drain or dual or damascene or copper or aluminum or opening)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 14:34
S43	1	"6004188".PN.	USPAT; USOCR	OR	ON	2005/10/20 14:25
S44	1	"5990015".PN.	USPAT; USOCR	OR	ON	2005/10/20 14:26
S45	1	"5969422".PN.	USPAT; USOCR	OR	ON	2005/10/20 14:26
S46	1	"5897369".PN.	USPAT; USOCR	OR	ON	2005/10/20 14:27
S47	1	"5817572".PN.	USPAT; USOCR	OR	ON	2005/10/20 14:27
S48	1	"5462890".PN.	USPAT; USOCR	OR	ON	2005/10/20 14:27
S49	1	("6723631").PN.	USPAT	OR	OFF	2005/10/20 14:34

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S54	1	S53 and (composite or etch or etching or stop or stopper or integrated or circuit or TEOS or overlying or carbon or silicon or carbide or thickness or silicate or polyimide or oxide or metal or source or drain or dual or damascene or copper or aluminum or opening)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/20 14:45
S55	1	("5969422").PN.	USPAT	OR	OFF	2005/10/20 14:45
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